| ASBOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES  | IPC. Bannockl  | ourn, Illinois, A          | Il rights reserved untions. | under both              | This docum<br>level parts, t                                  | ent is a declaration e | ion of the su                               | ibstances v<br>s all lower | within the manufactor<br>level materials for | urer listed which the   | item. Note<br>manufactur        | : if the item is an as<br>rer has engineering | sembly with low responsibility. |  |
|---|----------------|----------------------------|-----------------------------|-------------------------|---|------------------------|---|----------------------------|--|-------------------------|---------------------------------|---|---------------------------------|--|
|   |                |                            |                             | Form Type<br>Distribute | Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi |                        |   |                            | rials and N                                  | als and Mfg Information |                                 |   |                                 |  |
| upplier Information                               |                |                            |                             |                         |   |                        |   |                            |  |                         |                                 |   |                                 |  |
| Company name* Comp                                |                |                            | ompany unique ID            |                         |   | Unique ID Authority    |   |                            |  | Respon                  | Response Date*                  |   |                                 |  |
| onsemi  |                |                            |                             |                         |   |                        |   |                            |  |                         | 2025-09-17                      |   |                                 |  |
| Contact Name Title - Contact                      |                |                            | ct                          | t                       |   |                        | Phone - Contact*                            |                            |  |                         | Email - Contact*                |   |                                 |  |
| Product-Env-Stewards Product En                   |                |                            | Enviro Compliance           |                         |   | NA                     |   |                            |  | Produ                   | Product-Env-Stewards@onsemi.com |   |                                 |  |
| Authorized Representative* Title - Representative |                |                            | esentative                  |                         | Phone - Representative*                                       |                        |   |                            | Email  | Email - Representative* |                                 |   |                                 |  |
| Product-Env-Stewards Prod                         |                |                            | Product Enviro Compliance   |                         |   | NA                     |   |                            |  | Produ                   | Product-Env-Stewards@onsemi.com |   |                                 |  |
| Requester Item Number                             | Mfr Iten       | n Number                   | Mfr Item Name               |                         |   | Effective Date         | Date Version Manufacturing Site             |                            | Ianufacturing Site                           |                         | Weight*                         | UOM   | Unit Type                       |  |
|   | NCV112         | CV1124DR2G DUAL VARIABLE   |                             | LE-RELUCTAN             | NCE   | 2025-09-17             |   | P                          | PH1  |                         | 72.0                            | mg  | Each                            |  |
| Ianufacturing Proccess Information                | ation          |                            |                             |                         |   |                        |   |                            |  |                         |                                 |   |                                 |  |
| Terminal Plating / Grid Array M                   | Iaterial 7     | terial Terminal Base Alloy |                             | J-STD-020 MSI           | ) MSL Rating Pe   |                        | ak Process Body Temperature Max Time at Pea |                            | k Tempera                                    | ture Nur                | nber of Reflow Cyc              | eles  |                                 |  |
| Matte Tin (Sn) - annealed CU Alloy                |                | CU Alloy                   |                             | 1                       |   | 260                    |   | С                          | 30   | seco                    | nds 3                           |   |                                 |  |
| omments   |                |                            |                             |                         |   |                        |   |                            |  |                         |                                 |   |                                 |  |
| vel 1 - maximum time at peak temperat             | ture during so | ldering is 10-3            | 0 seconds                   |                         |   |                        |   |                            |  |                         |                                 |   |                                 |  |
| or more information regarding materia             | l composition  | please refer to            | o page 3                    |                         |   |                        |   |                            |  |                         |                                 |   |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless | otherwise noted). |                 |          |                            |                  |        |         |                 |
|------------------------------------|-------------------|-----------------|----------|----------------------------|------------------|--------|---------|-----------------|
| Homogeneous Material               | Weight            | Unit of Measure | Level    | Substance                  | CAS              | Exempt | Weight  | Unit of Measure |
| Die                                | 1.33              | mg              | Supplier | Silicon (Si)               | 7440-21-3        |        | 1.33    | mg              |
| Die Attach                         | 2.4               | mg              |          | Epoxy resin                | proprietary data |        | 0.24    | mg              |
|                                    |                   |                 | Supplier | Silver (Ag)                | 7440-22-4        |        | 1.92    | mg              |
|                                    |                   |                 | Supplier | Formaldehyde Polymer       | 9003-36-5        |        | 0.24    | mg              |
| Lead Frame                         | 37.61             | mg              | Supplier | Silver (Ag)                | 7440-22-4        |        | 0.7898  | mg              |
|                                    |                   |                 | Supplier | Zinc (Zn)                  | 7440-66-6        |        | 0.0752  | mg              |
|                                    |                   |                 | Supplier | Iron (Fe)                  | 7439-89-6        |        | 0.9403  | mg              |
|                                    |                   |                 | Supplier | Copper (Cu)                | 7440-50-8        |        | 35.8047 | mg              |
| Mold Compound-Black                | 28.58             | mg              |          | Epoxy resin                | proprietary data |        | 1.429   | mg              |
|                                    |                   |                 | Supplier | Phenolic Resin             | Proprietary Data |        | 0.5716  | mg              |
|                                    |                   |                 | Supplier | Ortho Cresol Novolac Resin | 29690-82-2       |        | 0.7145  | mg              |
|                                    |                   |                 | Supplier | Carbon Black (C)           | 1333-86-4        |        | 0.1429  | mg              |
|                                    |                   |                 | Supplier | Fused Silica (SiO2)        | 60676-86-0       |        | 25.722  | mg              |
| Plating                            | 1.89              | mg              | Supplier | Tin (Sn)                   | 7440-31-5        |        | 1.89    | mg              |
| Wire Bond - Au                     | 0.19              | mg              | Supplier | Gold (Au)                  | 7440-57-5        |        | 0.19    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).